

TOHOKU UNIVERSITY ENGINEERING SHORT PROGRAM 2026

Explore. Collaborate. Innovate.
Create the future in the winter of Tohoku.

TESP Winter 2026 is an intensive international program that combines research experience in Tohoku University laboratories with entrepreneurship-oriented, project-based learning.

Participants work in multicultural teams to explore real-world social challenges, develop value propositions, and consider implementation pathways while connecting specialized knowledge to possible solutions for society.

The program also includes field trip Japanese cultural experiences, and opportunities to interact with Tohoku University students.

PROGRAM DATES

Dec 3 (Thu) – Dec 18 (Fri), 2026
Arrival recommended Dec 2 (Wed), 2026

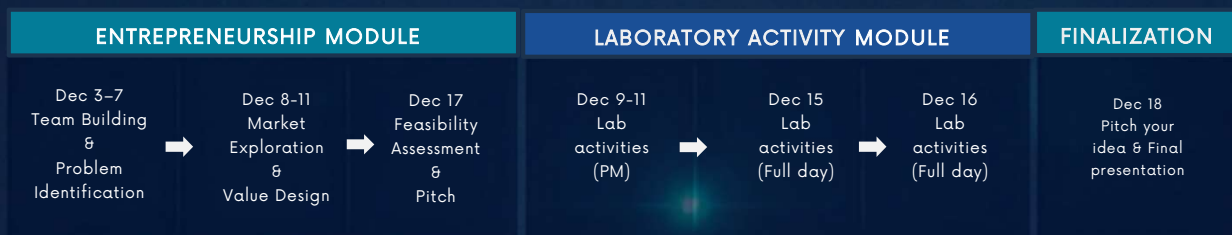
LOCATION

Aobayama Campus, Tohoku
University, Sendai, Japan

FACULTY LEAD

Dr. Stephane Yu Matsushita
School of Engineering, Tohoku University

PROGRAM STRUCTURE



SUPPORTING PROGRAM ELEMENTS

FIELD TRIP
Discover Tohoku and learn beyond the classroom

JAPANESE LANGUAGE & CULTURAL EXPERIENCES
Traditional tea ceremony and more

KEY INFORMATION

Language	English
Participants	Approx. 55 undergraduate, master's students
Program Fee	JPY 110,000 per student
Accommodation	Participants are responsible for arranging and paying for their own accommodation
Application Period	Aug. 27 – Sep. 24, 2026
Selection Results	Sep. 30, 2026
Scholarship	JASSO Scholarship JPY 80,000 for 8 students

PROGRAM GOALS

- Analyze real-world social and market challenges
- Connect engineering and research knowledge to social implementation
- Strengthen cross-cultural teamwork and communication
- Build practical skills in value proposition design and pitching
- Experience research at Tohoku University
- Experience Japanese culture and enjoy winter in the Tohoku region!

PARTICIPATING LABORATORIES

Participants will join one of the following academic fields and take part in research activities at Tohoku University:

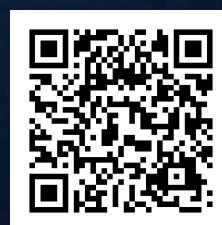
- Chemical & Biological Engineering
- Disaster Science
Tsunami Engineering/Disaster Risk Education
- Semiconductor Engineering

Applicants will be asked to indicate their preferred field/laboratory at the time of application. For detailed information on each field, eligibility, and research activities, please visit the TESP website.

HOW TO APPLY



LEARN MORE & APPLY



<https://www.ied.eng.tohoku.ac.jp/en/short-program>
Email: tesp-admin@grp.tohoku.ac.jp